EPO-TEK® Specialty Adhesives

for Sensor Applications



Epoxy Technology has an extensive offering of specialty adhesives for Sensor Applications: from Electrically Conductive, to Thermally Conductive, to Optical Grade Adhesives, as well as UV Epoxy and UV Hybrid Adhesives. Our EPO-TEK® brand adhesives are globally recognized for quality, performance and reliability.



Optical adhesives

Optical Applications - such as cameras, lasers, LEDs and photo-diodes, LiDAR and IR, where our optical, semiconductor die-attach, and UV curing products are used. EPO-TEK® products: **301-2**, **353ND**, **H20E**, **EK1000** and **OG198-54**.



Ultrasonic Adhesives

Ultrasonic Applications - such as in piezo fabrication and packaging, flex circuit assembly, electrical contacts and acoustic matching. EPO-TEK® products: **301**, **301-2FL**, **310M-1**, **353ND**, **EJ2189-LV** and **H20E**.



MEMS and IC Packaging Adhesives

MEMS and IC Packaging Applications - such as accelerometers, micro-actuators, gyroscopes and pressure sensors, where our EPO-TEK® products for semiconductor die-attach, wafer level spin coating, underfill, hermetic and hybrid microelectronics are used. EPO-TEK® products: **360**, **H20S**, **930-4**, **T6067-3**, **OJ2933-LH**, and **OD1001-67**.



RF/Radar Adhesives

RF/Radar Applications - such as hermetic and semi-hermetic packaging, transmitters and antenna, advanced driver assistance, and RFID transponders, where our EPO-TEK® products are used in semiconductor die attach, electrically and thermally conductive applications, and UV curing glob top. EPO-TEK® products: 353ND, H20S, H70E, H20E-PFC, OG116-31, OG142, and U300-2.



Biometric and Biosensor Adhesives

Biometric and Biosensor Applications - such as wearable electronics for fitness and consumer health, fingerprint and retinal scanners, gesture and movement recognition and bio-tech remote monitoring. EPO-TEK® products: MED-301, MED-320, MED-353ND, MED-T7110, MED-H20E, and EJ2189-LV.

SELECTED PRODUCT LISTINGS FOR SENSOR APPLICATIONS

	EPO-TEK®	COLOR Before/After CURE (thin film)	CURE CONDITIONS (minimal)	VISCOSITY @ 23°C (cP	s) INDEX OF REFRACTION Nd @589nm	POT LIFE (@ room temp)
OPTICAL	301	Clear / Colorless	65°C - 1 hour 23°C - 24 hours	@ 100 rpm 100 - 200	1.5190	1-2 hours
	301-2	Clear / Colorless	80°C - 3 hours 23°C - 2 days	@ 100 rpm 225 - 425	1.5318	8 hours
	301-2FL	Clear / Colorless	80°C - 3 hours 23°C - 3 days	@ 100 rpm 100 - 200	1.5102	10 hours
	310M-1	Clear / Colorless	65°C - 2 hours 23°C - 24 hours	@ 100 rpm 100 - 600	1.5129	2 hours
	353ND	Amber / Dark Amber	150°C - 1 min 80°C - 30 min	@ 50 rpm 3,000 - 5,000	1.5694	3 hours
	360	Light Yellow / Dark Amber	150°C - 1 min 100°C - 10 min	@ 100 rpm 350 - 550	1.5345	6 hours
	OD1001-67	Cream / Yellow	150°C - 1 hour	@ 100 rpm 1,000 - 2,500	1.5247	28 days
	OJ2933-LH	Light Yellow / Amber	150°C - 1 hour	@ 1 rpm 65,000 - 140,000	1.5686	2 days
	U300-2	Amber / Dark Amber	150°C - 1 hour	@ 20 rpm 3,700 - 6,700	1.5746	2 days
THERMAL	EPO-TEK®	CURE CONDITIONS (minimal)	VISCOSITY @ 23°C (cPs)	DIE SHEAR STRENGTH @ (80 mil X 80 mil)	RT THERMAL CONDUCTIVITY (W/m°K)	POT LIFE (@ room temp)
	930-4	150°C - 1 hour 80°C - 6 hours	@ 20 rpm 12,000 - 17,000	≥15kg / 5,334psi	1.70	1 day
	T6067-3	150°C - 1 hour	@ 1 rpm 100,000 - 150,000	≥25kg / 8,890psi	1.00	28 days
	T7110	80°C - 2 hours 23°C - 3 days	@ 100 rpm 1,400 - 2,200	≥10kg / 3,556psi	1.00	3.5 hours
ELECTRICAL	EPO-TEK®	CURE CONDITIONS (minimal)	VISCOSITY @ 23°C (cPs)	VOLUME RESISTIVITY (ohm-cm)	THERMAL CONDUCTIVITY (W/m°K)	POT LIFE (@ room temp)
	EJ2189-LV	150°C - 1 hour 23°C - 3 days	@ 1 rpm 25,000 - 45,000	≤0.009	2.50	4 hours
	EK1000	150°C - 1 hour + 200°C - 1 hour (post)	@ 100 rpm 1,800 - 3,600	≤0.00009	12.60 26.30	2 weeks
	H20E	150°C - 5 min 80°C - 3 hours	@ 100 rpm 2,200 - 3,200	≤0.0004	2.50	2.5 days
	H20E-PFC	175°C - 45 sec 80°C - 3 hours	@ 100 rpm 3,000 - 4,000	≤0.0004	3.20	3 days
	H2OS	150°C - 5 min 80°C - 90 min	@ 100 rpm 1,800 - 2,800	<0.0005	3.30	3 days
۸۵	EPO-TEK®	CURE CONDITIONS 100mW/cm2 @ 240 - 365nm (minimal)	VISCOSITY @ 23°C (cPs)	INDEX OF REFRACTION Nd @589nm	PERFORMANCE FEATURES	
	OG116-31	> 30 sec	@ 10 rpm 20,000 - 30,000	1.5842	High chemical resistance, high Tg & high index	
	OG142	> 30 sec	@ 20 rpm 9,000 - 15,000	1.5809	Medium viscosity, high strength, moisture resistance	
	OG198-54	> 30 sec	@ 100 rpm 200 - 450	1.5256	Low viscosity, high Tg, shadow curing	
<u>_</u>	EPO-TEK®	PERFORMANCE FEATURES				

a	ЕРО-ТЕК®	PERFORMANCE FEATURES		
Biocompatible/Medica	MED-301	Clear, low viscosity, room temp cure, used for potting		
	MED-320	Black, opaque, thixotropic paste, room temp cure, potting, low fluorescence		
	MED-323LP	Medium viscosity, long pot life with high Tg		
	MED-353ND	Medium viscosity, high Tg, high strength (worldwide standard for optics)		
CO	MED-H20E	Smooth thixotropic paste, ECA with high thermal conductivity and high reliability		
Bio	MED-T7110	Pourable, TCA with low viscosity, potting		

All EPO-TEK® Medical Device grade adhesives ("MED") are ISO 10993 tested for biocompatibility





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DISCLAIMER: Data presented is provided only to be used as a guide. Properties listed are typical, average values, based on tests believed to be accurate. It is recommended that users perform a thorough evaluation for any application based on their specific requirements. Epoxy Technology makes no warranties (expressed or implied) and assumes no responsibility in connection with the use or inability to use these products.

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